



2826

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of: DARMAWAN

Attorney Docket No. CREEP027/P0211

Application No.: 10/053,424

Examiner: TRAN, Tan

Filed: November 2, 2001

Group: 2826

Title: SILICON ON INSULATOR DEVICE WITH  
IMPROVED HEAT REMOVAL (As amended)

RECEIVED  
SEP 16 2003  
TECHNICAL CENTER 2800

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as first-class mail on September 11, 2003 in an envelope addressed to the Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

Signed

  
Kristina Gomez

**RESPONSE C**

Mail Stop Non-Fee Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action dated July 16, 2003, reconsideration is respectfully requested in view of the following remarks.

**REMARKS**

This Response is submitted to the Office Action mailed July 16, 2003, in which claim 15 has been rejected under 35 USC § 102(e) as being anticipated by newly cited Udrea et al. (2002/0041003) (hereinafter "Udrea") and claims 21-23 have been rejected under 35 USC § 103(a) as being unpatentable over Udrea in view of previously cited Lin 6,483,147.

These rejections are respectfully traversed with respect to claims 15 and 21-23, since Udrea do not disclose the silicon on insulator (SOI) semiconductor device as defined by claim 15, and Udrea in view of Lin do not suggest the semiconductor device as defined by dependent claims 21-23.